Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Manufacturing Info/ Material Info	Subsectionals	D, A

Supplier Information							
Company Name	TE Connectivity	**Request Document ID**		**Contact Name**	Wu, Cc	**Contact Title**	Prod Compliance Engineer, China CIS Compliance
Company Unique ID	TE Connectivity	**Response Date**	2016-02-26	**Contact Email**	cc.wu@te.com		
Contact Phone Number		86-21-33259321					

Legal Statement	
Supplier Acceptance	true

Legal Statement

The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.

Product							
Manufacturer Item number	1-794040-1	**Amount**	3537.616	**Version**	-	**Identity**	
Manufacturer Item Name	12P MINI UMNL HDR ASSY AUBR LF	**Weight Uom**	mg	**Mfr Site**		**Authority**	
Date		**UOM**	Each				
EURoHS-0508	Product(s) meets EU RoHS requirement without any exemptions						
ChinaRoHS-0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products						
EUREACH-0615	REACH Candidate Substances of Very High Concern ARE NOT Yet Reviewed						

Manufacturing Information							
J-STD-020 MSL Rating		**Max Total a Wave Time**		**Ramp Rate**		**Wave Additional Info**	
Classification Temp		**Max Wave Solder Time**	10.0	**Ramp Down Rate**		**Psl Rating Reflow**	
Max Time Within 5		**Psl Rating Wave**		**Package Designator**		**Size**	0.0
Time Above 217		**Reflow Additional Info**		**Preheat Max Temp**		**Terminal Base Alloy**	Cu Alloy
Preheat Duration		**bulk Solder Termination**	NAC	**Nbr or Reflow Cycles**		**Terminal Plating**	Matte Tin (Sn) - reflowed over Nickel (Ni) barrier
Preheat Min Temp		**Nbr of Instances**	0	**Component Temp Spike**		**Shape**	NAC

Product Disclosure

Sub-Item/Material/ Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Sub-Item	1	12P MINI UMNL HSG				1.0	2219.5	mg	
Material	2	PA				1.0	2219.5	mg	
Substance	3	Water	Supplier	7732-18-5	0.3262	1.0	7.24001	mg	
Substance	3	2H-Azepin-2-one, hexahydro-	Supplier	105-60-2	0.4637	1.0	10.29182	mg	
Substance	3	Siloxanes and Silicones, di-Me	Supplier	63148-62-9	3.0E-4	1.0	0.0066585	mg	
Substance	3	Poly[imino(1,6-dioxo-1,6-hexanediyl)imino-1,6-hexanediyl]	Supplier	32131-17-2	0.9451	1.0	20.97649	mg	
Substance	3	Benzenepropanamide, N,N-1,6-hexanediylbis[3,5-bis(1,1-dimethylethyl)-4-hydroxy-	Supplier	23128-74-7	0.4004	1.0	8.88688	mg	
Substance	3	1,2-Ethanediamine	Supplier	107-15-3	0.0033	1.0	0.0732435	mg	
Substance	3	Phosphoric acid, sodium salt, hydrate (1:2:12)	Supplier	10039-32-4	0.025	1.0	0.55488	mg	
Substance	3	Octadecanoic acid, calcium salt (2:1)	Supplier	1592-23-0	0.2012	1.0	4.46563	mg	
Substance	3	Octadecanamide, N,N-1,2-ethanediylbis-	Supplier	110-30-5	0.1901	1.0	4.21927	mg	

Substance	3	1,3,5-Triazine-2,4,6(1H,3H,5H)-trione, compd. with 1,3,5-triazine-2,4,6-triamine (1:1)	Supplier	37640-57-6	9.0717	1.0	201.34638	mg	
Substance	3	Hexanedioic acid, polymer with hexahydro-2H-azepin-2-one and 1,6-hexanediamine	Supplier	24993-04-2	88.373	1.0	1961.43874	mg	
Sub-Item	1	MINI UMNL BAND PIN SNAU LF				12.0	109.843	mg	
Material	2	Brass Wire				12.0	108.0	mg	
Substance	3	Copper	Supplier	7440-50-8	71.5	12.0	77.22	mg	
Substance	3	Beryllium	Supplier	7440-41-7	0.0010	12.0	0.00108	mg	
Substance	3	Zinc	Supplier	7440-66-6	28.0226	12.0	30.26441	mg	
Substance	3	Manganese	Supplier	7439-96-5	0.05	12.0	0.054	mg	
Substance	3	Chromium	Supplier	7440-47-3	0.0010	12.0	0.00108	mg	
Substance	3	Iron	Supplier	7439-89-6	0.05	12.0	0.054	mg	
Substance	3	Cobalt	Supplier	7440-48-4	0.1	12.0	0.108	mg	
Substance	3	Arsenic	Supplier	7440-38-2	0.0099	12.0	0.010692	mg	
Substance	3	Antimony	Supplier	7440-36-0	0.01	12.0	0.0108	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.05	12.0	0.054	mg	
Substance	3	Cadmium	Cadmium/Cadmium Compounds	7440-43-9	0.0050	12.0	0.0054	mg	
Substance	3	Mercury	Mercury/Mercury Compounds	7439-97-6	5.0E-4	12.0	5.4E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	0.2	12.0	0.216	mg	
Material	2	Tin Plate				12.0	0.923	mg	
Substance	3	Tin	Supplier	7440-31-5	99.73	12.0	0.92051	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	12.0	0.001846	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.07	12.0	6.461E-4	mg	
Material	2	Gold Plate				12.0	0.273	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-0909	1.0	12.0	0.00273	mg	
Substance	3	Gold	Supplier	7440-57-5	99.0	12.0	0.27027	mg	
Material	2	Nickel Plate				12.0	0.647	mg	
Substance	3	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.2	12.0	0.001294	mg	
Substance	3	Lead	Lead/Lead Compounds	7439-92-1	0.1	12.0	6.47E-4	mg	
Substance	3	Nickel	Nickel	7440-02-0	99.7	12.0	0.64506	mg	